

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -
Wholesale and Retail.

Phase Control Disc Thyristor Type DT99-2500-52

High power cycling capability / Low on-state and switching losses
 Designed for traction and industrial applications

Mean on-state current	I _{TAV}	2500 A		
Repetitive peak off-state voltage	V _{DRM}	4600 ÷ 5200 V		
Repetitive peak reverse voltage	V _{RRM}			
Turn-off time	t _q	800 µs		
V _{DRM} , V _{RRM} , V	4600	4800	5000	5200
Voltage code	46	48	50	52
T _j , °C		– 60 ÷ 125		

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I _{TAV}	Mean on-state current	A	2500 3600	T _c = 94 °C, Double side cooled T _c = 70 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TRMS}	RMS on-state current	A	3925	T _c = 94 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current	kA	55.0 63.0	T _j =T _j _{max} T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
			58.0 67.0	T _j =T _j _{max} T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
I ² t	Safety factor	A ² s·10 ³	15100 19800	T _j =T _j _{max} T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
			13900 18600	T _j =T _j _{max} T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
BLOCKING					
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	4600÷5200	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz; Gate open	
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	4700÷5300	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; single pulse; Gate open	
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.6·V _{DRM} 0.6·V _{RRM}	T _j =T _j _{max} ; Gate open	

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TRIGGERING				
I_{FGM}	Peak forward gate current	A	12	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	1000	$T_j = T_{j\max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60 ÷ 50	
T_j	Operating junction temperature	°C	-60 ÷ 125	
MECHANICAL				
F	Mounting force	kN	70.0 ÷ 90.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	2.10	$T_j = 25$ °C; $I_{TM} = 6300$ A		
$V_{T(TO)}$	On-state threshold voltage, max	V	1.00	$T_j = T_{j\max}$;		
r_T	On-state slope resistance, max	$m\Omega$	0.190	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$		
I_L	Latching current, max	mA	1500	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s		
I_H	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open		
BLOCKING						
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j\max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	500, 1000, 1600	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	5.00 3.00 2.00	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	500 300 200	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$;		
I_{GD}	Gate non-trigger direct current, min	mA	15.00	Direct gate current		
SWITCHING						
t_{gd}	Delay time	μ s	4.00	$T_j = 25$ °C; $V_D = 1500$ V; $I_{TM} = I_{TAV}$; $di/dt = 200$ A/ μ s; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ μ s		
t_q	Turn-off time ²⁾ , max	μ s	800	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j\max}$; $I_{TM} = 1000$ A; $di_R/dt = -5$ A/ μ s; $V_R = 100$ V; $V_D = 1600$ V;		
Q_{rr}	Total recovered charge, max	μ C	12500	$T_j = T_{j\max}$; $I_{TM} = 1000$ A; $di_R/dt = -5$ A/ μ s;		
t_{rr}	Reverse recovery time, typ	μ s	157	$V_R = 100$ V		
I_{rrM}	Peak reverse recovery current, max	A	159			

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THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0057	Direct current	Double side cooled
R_{thjc-A}			0.0125		Anode side cooled
R_{thjc-K}			0.0103		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0010	Direct current	

MECHANICAL					
w	Weight, max	g	2700		
D_s	Surface creepage distance	mm (inch)	62.09 (2.444)		
D_a	Air strike distance	mm (inch)	23.40 (0.921)		

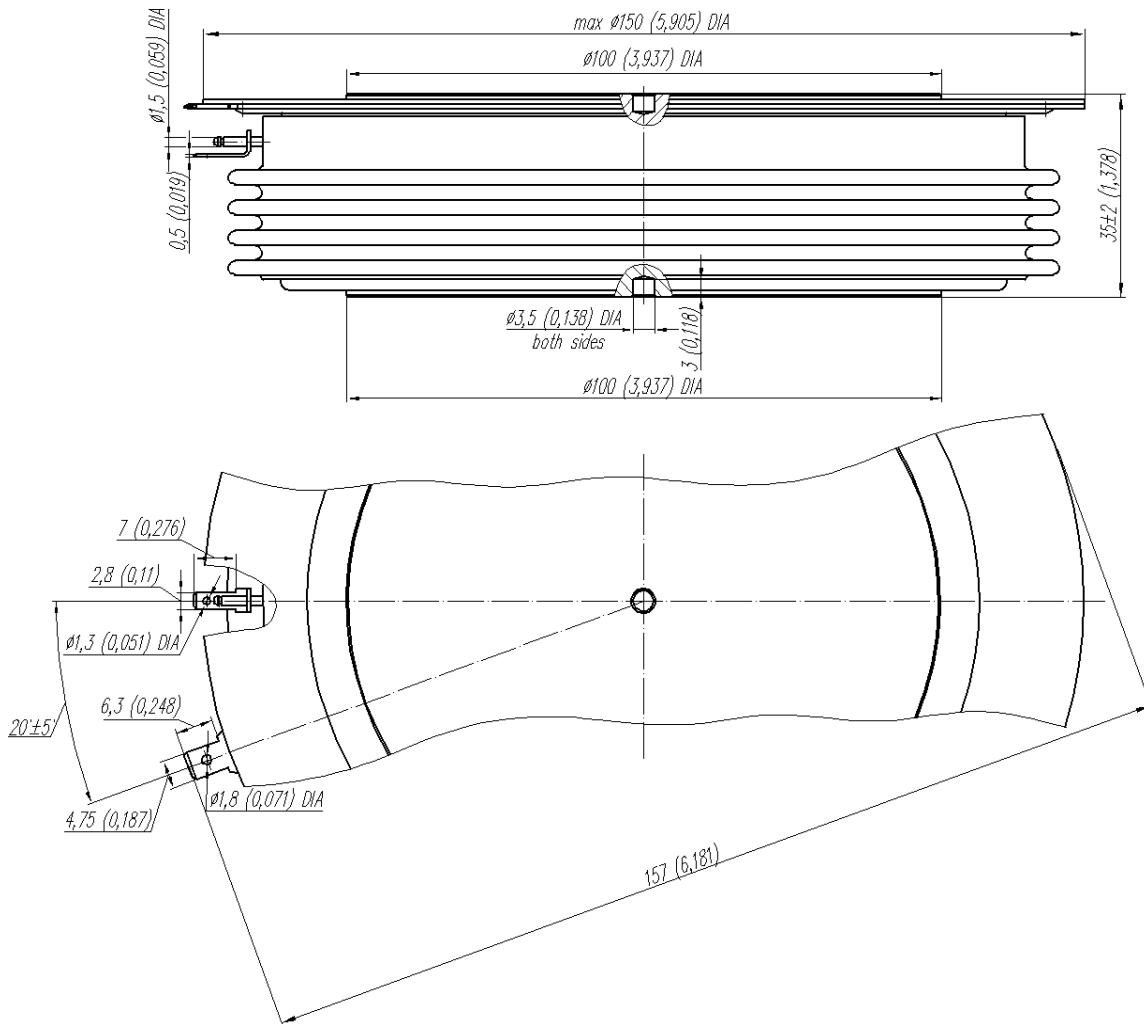
PART NUMBERING GUIDE						NOTES															
<table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td>DT</td><td>99</td><td>2500</td><td>52</td><td>7</td><td>3</td></tr> <tr> <td>1</td><td>2</td><td>3</td><td>4</td><td>5</td><td>6</td></tr> </table>						DT	99	2500	52	7	3	1	2	3	4	5	6	¹⁾ Critical rate of rise of off-state voltage			
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1. DT - Phase Control Disc Thyristor 2. Element Diameter 3. Mean on-state current, A 4. Voltage code 5. Critical rate of rise of on-state current non-repetitive, V/ μs 6. Turn-off time ($\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$)						<table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td>Symbol of Group $(\text{dv}_D/\text{dt})_{\text{crit}}, \text{V}/\mu\text{s}$</td><td>6</td><td>7</td><td>8</td></tr> <tr> <td></td><td>500</td><td>1000</td><td>1600</td></tr> </table>				Symbol of Group $(\text{dv}_D/\text{dt})_{\text{crit}}, \text{V}/\mu\text{s}$	6	7	8		500	1000	1600				
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OVERALL DIMENSIONS

Package type: T.G6



All dimensions in millimeters (inches)